TOSHIBA Photocoupler IRED + Photo IC

TLP750

Digital Logic Ground Isolation
Line Receiver
Microprocessor System Interfaces
Switching Power Supply Feedback Control
Analog Signal Isolation
Transistor Inverter

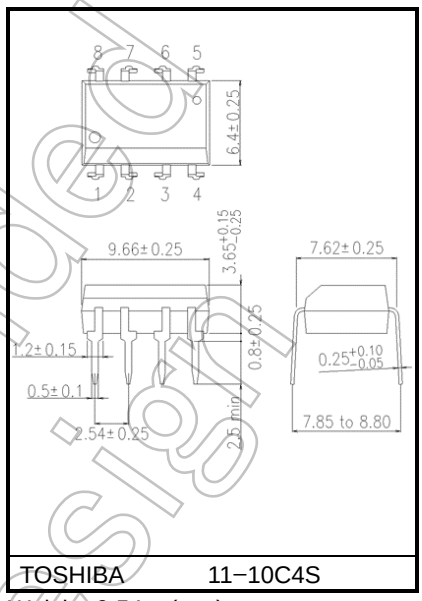
The TOSHIBA TLP750 consists of a high-output infrared light emitting diode optically coupled to a high-speed photodiode with a transistor amplifier and is housed in an 8-pin DIP.
The TLP750 has no internal base connection and features noise immunity, thus it is suitable for inverter drivers for variable-speed motor drives.

- Switching speed: t_{pHL}=0.3μs (typ.)
- Switching speed: t_{pLH}=0.5μs (typ.) (R_L=1.9kΩ)
- Isolation voltage: 5000 V_{rms} (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A
  File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)

Note 1 : When a VDE approved type is needed, please designate the **Option(D4)**.

- Creepage distance: 6.4mm (min)
  Clearance: 6.4mm (min)
  Insulation thickness: 0.4mm (min)

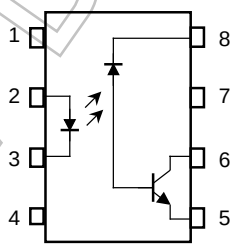
Unit: mm



TOSHIBA 11−10C4S

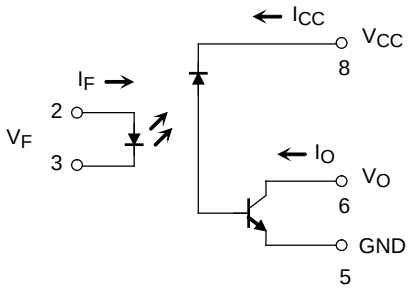
Weight: 0.54 g (typ.)

Pin Configuration (top view)



1 : N.C.
2 : Anode
3 : Cathode
4 : N.C.
5 : Emitter
6 : Collector
7 : N.C.
8 : V_{CC}

Schematic



Start of commercial production
1989-10

Absolute Maximum Ratings (Ta = 25°C)

Characteristic			Symbol	Rating	Unit
LED	Forward current	(Note 1)	I_F	25	mA
	Pulse forward current	(Note 2)	I_{FP}	50	mA
	Peak transient forward current	(Note 3)	I_{FPT}	1	A
	Reverse voltage		V_R	5	V
	Diode power dissipation	(Note 4)	P_D	45	mW
Detector	Output current		I_O	8	mA
	Peak output current		I_{OP}	16	mA
	Output voltage		V_O	−0.5 to 15	V
	Supply voltage		V_{CC}	−0.5 to 15	V
	Output power dissipation	(Note 5)	P_O	100	mW
Operating temperature range			T_{opr}	−55 to 100	°C
Storage temperature range			T_{stg}	−55 to 125	°C
Lead solder temperature(10 s)		(Note 6)	T_{sol}	260	°C
Isolation voltage (AC, 60 s, R.H.= 60 %)		(Note 7)	BV_S	5000	V_{rms}

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

(Note 1) Derate 0.8 mA / °C above 70 °C.

(Note 2) 50 % duty cycle, 1ms pulse width.
Derate 1.6 mA / °C above 70 °C.

(Note 3) Pulse width ≤ 1 μs, 300 pps.

(Note 4) Derate 0.9 mW / °C above 70 °C.

(Note 5) Derate 2 mW / °C above 70 °C.

(Note 6) Soldering portion of lead: Up to 2mm from the body of the device.

(Note 7) Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

Electrical Characteristics (Ta = 25°C)

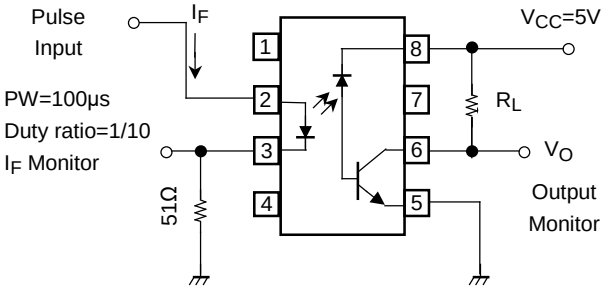
Characteristic		Symbol	Test Condition		Min	Typ.	Max	Unit
LED	Forward voltage	V_F	I_F = 16 mA		—	1.65	1.85	V
	Forward voltage temperature coefficient	$\Delta V_F / \Delta Ta$	I_F = 16 mA		—	−2	—	mV / °C
	Reverse current	I_R	V_R = 5 V		—	—	10	μA
	Capacitance between terminal	C_T	V_F = 0 V, f = 1 MHz		—	45	—	pF
Detector	High level output current	$I_{OH(1)}$	I_F = 0 mA, V_{CC} = V_O = 5.5 V		—	3	500	nA
		$I_{OH(2)}$	I_F = 0 mA, V_{CC} = V_O = 15 V		—	—	5	μA
		I_{OH}	I_F = 0 mA, V_{CC} = V_O = 15 V, Ta = 70 °C		—	—	50	μA
	High level supply voltage	I_{CCH}	I_F = 0 mA, V_{CC} = 15 V		—	0.01	1	μA
Coupled/ Insulation	Current transfer ratio	I_O/I_F	I_F = 16 mA, V_{CC} = 4.5 V, V_O = 0.4 V	Ta = 25° C	10	30	—	%
				Rank: O	19	30	—	
				Ta = 0 to 70 °C	5	—	—	
				Rank: O	15	—	—	
	Low level output voltage	V_{OL}	I_F = 16 mA, V_{CC} = 4.5 V, I_O = 1.1 mA (rank O: I_O = 2.4 mA)		—	—	0.4	V
	Isolation resistance	R_S	R.H.≤ 60 %, V_S = 500 V_{DC} (Note 7)		1×10^{12}	10^{14}	—	Ω
	Capacitance between input to output	C_S	V_S = 0 V, f = 1 MHz (Note 7)		—	0.8	—	pF
	Isolation Voltage	BV_S	AC, 60 s (Note 7)		5000	—	—	Vrms

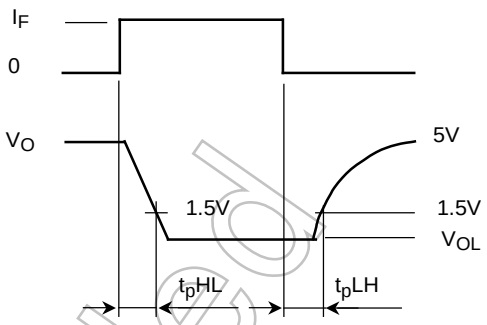
Switching Characteristics (Ta = 25°C, V_{CC} = 5V)

Characteristic	Symbol	Test Circuit	Test Condition		Min	Typ.	Max	Unit
Propagation delay time (H→L)	t_{pHL}	1	I_F = 16 mA, R_L = 4.1 kΩ		—	0.2	0.8	μs
				Rank O: R_L=1.9 kΩ	—	0.3	0.8	
Propagation delay time (L→H)	t_{pLH}		I_F = 16 mA, R_L = 4.1 kΩ		—	1	2	μs
				Rank O: R_L = 1.9 kΩ	—	0.5	1.2	
Common mode transient immunity at logic high output (Note 8)	CM_H	2	I_F = 0 mA, V_{CM} = 200 V_{p-p}, R_L=4.1 kΩ (Rank O: R_L = 1.9 kΩ)		—	1500	—	V / μs
Common mode transient immunity at logic low output (Note 8)	CM_L		I_F = 16 mA, V_{CM} = 200 V_{p-p}, R_L = 4.1 kΩ (Rank O: R_L = 1.9 kΩ)		—	−1500	—	V / μs

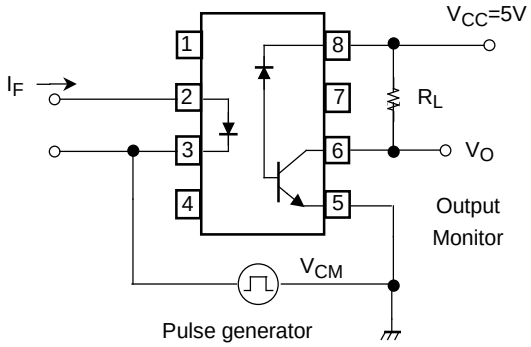
(Note 8) CM_L is the maximum rate of fall of the common mode voltage that can be sustained with the output voltage in the logic low state (V_O < 0.8 V).
CM_H is the maximum rate of rise of the common mode voltage that can be sustained with the output voltage in the logic high state (V_O > 2.0 V).

Test Circuit 1: Switching Time Test Circuit

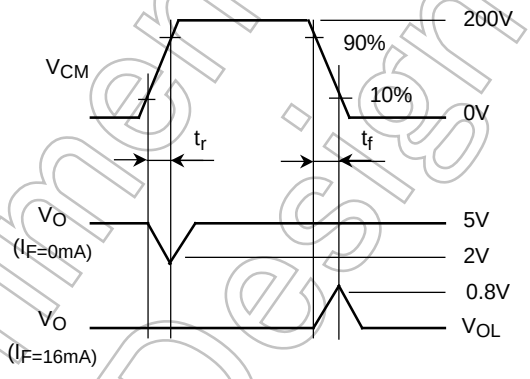




Test Circuit 2: Common Mode Noise Immunity Test Circuit

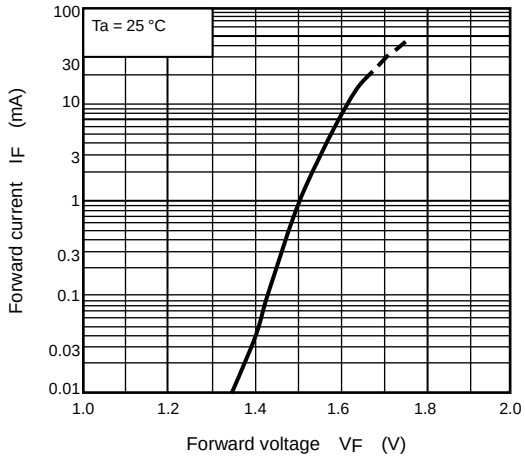


Z_O=50Ω

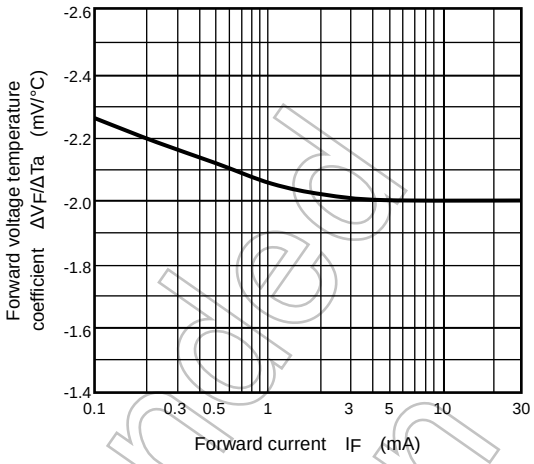


$$CM_H = \frac{160(V)}{t_r(\mu s)}, CM_L = \frac{160(V)}{t_f(\mu s)}$$

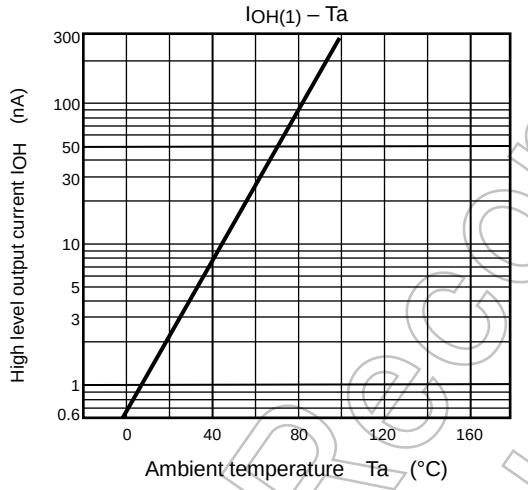
$I_F - V_F$



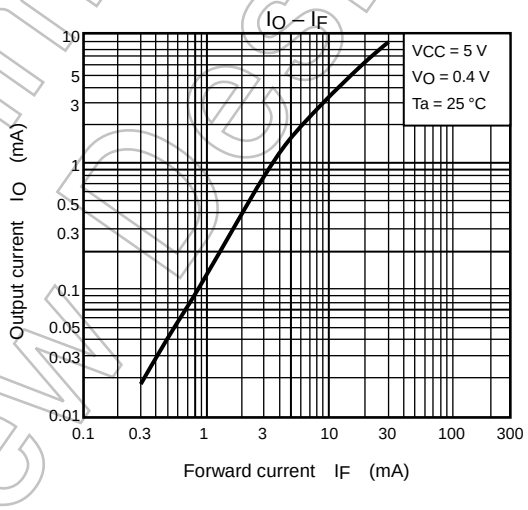
$\Delta V_F/\Delta Ta - I_F$



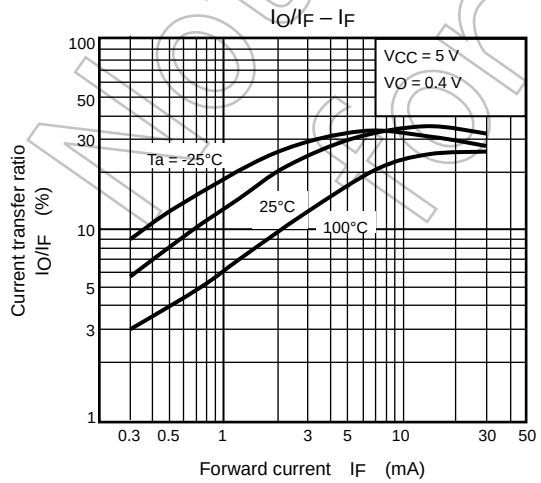
$I_{OH(1)} - Ta$



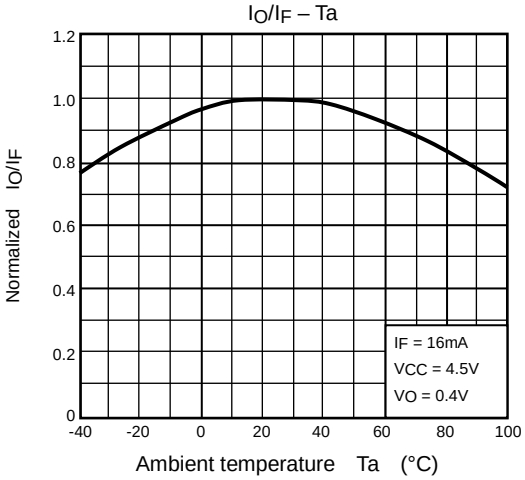
$I_O - I_F$



$I_O/I_F - I_F$

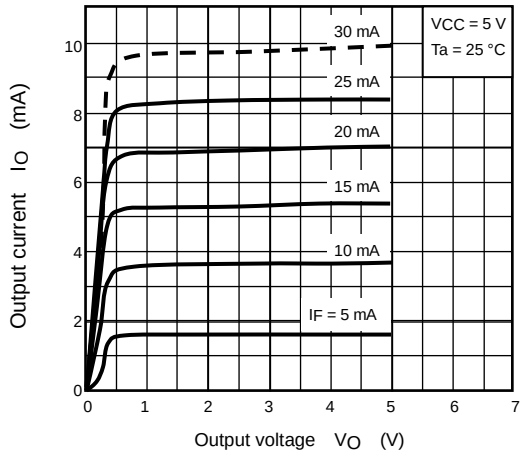


$I_O/I_F - Ta$

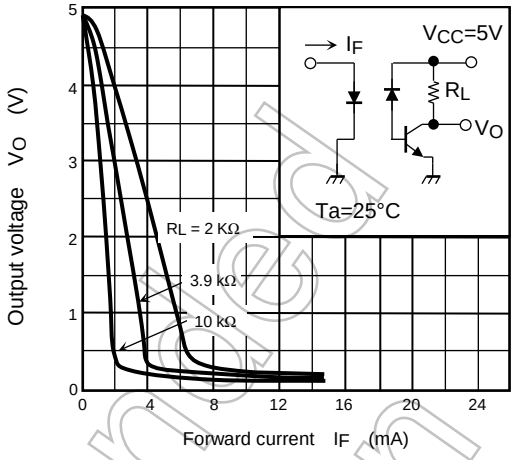


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

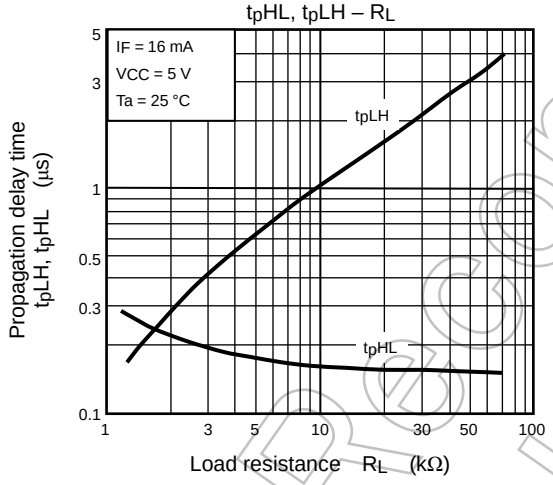
$I_O - V_O$



$V_O - I_F$



$t_{pHL}, t_{pLH} - R_L$



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